

C1206X472K5GACTU

Aliases (C1206X472K5GAC7800) SMD Comm COG Flex, Ceramic, 4,700 pF, 10%, 50 VDC, COG, SMD, MLCC, FT-CAP, Ultra-Stable, 1206, 1.5 mm



Click here for the 3D model.

General Information	
Series	SMD Comm COG Flex
Style	SMD Chip
Description	SMD, MLCC, FT-CAP, Ultra- Stable
Features	FT-CAP, Ultra-Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	20 mg
Shelf Life	78 Weeks
MSL	1

	Specifications	
	Capacitance	4,700 pF
m	Measurement Condition	1 kHz 1.0Vrms
m	Tolerance	10%
nm	Voltage DC	50 VDC
	Dielectric Withstanding Voltage	125 VDC
nm	Temperature Range	-55/+125°C
	Temp. Coefficient	COG
astic Tape	Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
	Dissipation Factor	0.1% 1 kHz 1.0Vrms
	Aging Rate	0% Loss/Decade Hour

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Insulation Resistance	100 GOhms

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

Chip Size	1206
L	3.3mm +/-0.4mm
W	1.6mm +/-0.35mm
т	0.9mm +/-0.20mn
S	1.5mm MIN
В	0.6mm +/-0.25mm

Packaging Specifications F

Dimensions

Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	4000